

Amendments to the Claims:

This listing of claims replaces all prior versions and listings of claims in the application:

Listing of Claims:

1. (Cancelled)
2. (Currently Amended) A light emitting device comprising:
a substrate having a metallic surface;
~~an~~ a first insulating film over [[a]] the substrate having [[a]] the metallic surface; and
at least one thin film transistor over the first insulating film;
a second insulating film over the at least one thin film transistor;
a light shielding film over the second insulating film; and
a light emitting element over the ~~insulating film~~ light shielding film;
said light emitting element including:
 - an anode;
 - a cathode; and
 - an EL material interposed between the anode and the cathode; and~~a light shielding film provided between the light emitting element and the substrate~~
~~having the metallic surface and overlapped with the light emitting element,~~
wherein a thickness of the substrate having the metallic surface is in a range of 5 to 30 μm ~~[[.]], and~~
wherein the light shielding film is made of a resin film.
- 3-7. (Cancelled)
8. (Withdrawn) A method of manufacturing a light emitting device, said method comprising the steps of:

bending edge portions of a substrate having a metallic surface;
fixing the substrate to a substrate holder;
forming an insulating film over the substrate having the metallic surface;
forming a light emitting element on the insulating film; and
separating the substrate from the substrate holder.

9. (Withdrawn) A method according to claim 8,
wherein the fixing step is performed within a vacuum.

10. (Withdrawn) A method according to claim 8,
wherein the fixing step is performed at a temperature in a range of room temperature to
400.

11. (Withdrawn) A method according to claim 8,
wherein edge portions of the substrate holder have curvature.

12. (Withdrawn) A method according to claim 8,
wherein the substrate holder has a same thermal expansion coefficient as the substrate
having the metallic surface.

13. (Withdrawn) A method according to claim 8,
wherein the substrate having the metallic surface is a heat resistive metallic substrate.

14. (Withdrawn) A method according to claim 8,
wherein a thickness of the heat resistant metallic substrate is in a range of 5 to 30 μm .

15. (Withdrawn) A method according to claim 8,
wherein the substrate holder comprises one selected from the group consisting of stainless steel, ceramic and Al_2O_3 .

16. (Withdrawn) A method according to claim 8,
wherein the substrate holder has a thickness in a range of $500\mu\text{m}$ to $1000\mu\text{m}$.

17. (Original) A device according to claim 2,
wherein the substrate having the metallic surface is a heat resistive metallic substrate.

18. (Cancelled)

19. (Original) A device according to claim 2,
wherein a maximum surface roughness (R_{max}) of the substrate is equal to or less than $1\mu\text{m}$.

20. (Original) A device according to claim 2,
wherein a radius of curvature of convex portions existing on a surface of the substrate is equal to or greater than $1\mu\text{m}$.

21. (Original) A device according to claim 2,
wherein the light emitting device is one selected from the group consisting of a video camera, a digital camera, a goggle-type display, a navigation system for vehicles, a personal computer, and a portable information terminal.

22. (Previously Presented) A device according to claim 2,
wherein the light shielding film is formed in contact with the cathode.

23. (Previously Presented) A device according to claim 2,
wherein the shielding film is formed adjacent to the cathode with an insulating film or a
conductive film interposed therebetween.

24. (Currently Amended) A light emitting device comprising:
a metal substrate;
an insulating film over a first surface of the metal substrate;
a light emitting element over the insulating film;
said light emitting element including:
an anode;
a cathode; and
an EL material interposed between the anode and the cathode, and
a substrate holder under a majority of a surface of the metal substrate opposite the first
surface[[]],
wherein the substrate holder is made of stainless steel, ceramic or alumina.

25. (Previously Presented) A device according to claim 24,
wherein the metal substrate is a heat resistive metallic substrate.

26. (Previously Presented) A device according to claim 25,
wherein a thickness of the heat resistive metallic substrate is in a range of 5 to 30 μm .

27. (Previously Presented) A device according to claim 24,
wherein a maximum surface roughness (Rmax) of the substrate is equal to or less than
1 μm .

28. (Previously Presented) A device according to claim 24,

wherein a radius of curvature of convex portions existing on a surface of the substrate is equal to or greater than 1 μm .

29. (Previously Presented) A device according to claim 24,
wherein the light emitting device is one selected from the group consisting of a video camera, a digital camera, a goggle-type display, a navigation system for vehicles, a personal computer, and a portable information terminal.

30. (Currently Amended) A light emitting device comprising:
a substrate holder;
a metal substrate over the entire surface of the substrate holder;
an insulating film over the metal substrate; and
a light emitting element over the insulating film;
said light emitting element including:
an anode;
a cathode; and
an EL material interposed between the anode and the cathode; and
a light shielding film provided between the light emitting element and the substrate having the metallic surface and overlapped with the light emitting element[[.]],
wherein the substrate holder is made of stainless steel, ceramic or alumina.

31. (Previously Presented) A device according to claim 30,
wherein the metal substrate is a heat resistive metallic substrate.

32. (Previously Presented) A device according to claim 31,
wherein a thickness of the heat resistive metallic substrate is in a range of 5 to 30 μm .

33. (Previously Presented) A device according to claim 30,
wherein a maximum surface roughness (R_{max}) of the substrate is equal to or less than
1 μm .

34. (Previously Presented) A device according to claim 30,
wherein a radius of curvature of convex portions existing on a surface of the substrate is
equal to or greater than 1 μm .

35. (Previously Presented) A device according to claim 30,
wherein the light emitting device is one selected from the group consisting of a video
camera, a digital camera, a goggle-type display, a navigation system for vehicles, a personal
computer, and a portable information terminal.

36. (Previously Presented) A device according to claim 30,
wherein the light shielding film is formed in contact with the cathode.

37. (Previously Presented) A device according to claim 30,
wherein the shielding film is formed adjacent to the cathode with an insulating film or a
conductive film interposed therebetween.

38. (Currently Amended) A light emitting device comprising:
a metal substrate;
a first insulating film over a first surface of the metal substrate;
at least one thin film transistor over the first insulating film;
a second insulating film over the at least one thin film transistor;
a first electrode over the second insulating film wherein the first electrode is electrically
connected with the thin film transistor;
a light emitting layer over the first electrode;

a second electrode over the light emitting layer; and
a substrate holder under a majority of a surface of the metal substrate opposite the first surface[[]],

wherein the substrate holder is made of stainless steel, ceramic or alumina.

39. (Previously Presented) A device according to claim 38,
wherein the metal substrate is a heat resistive metallic substrate.

40. (Previously Presented) A device according to claim 39,
wherein a thickness of the heat resistive metallic substrate is in a range of 5 to 30 μm .

41. (Previously Presented) A device according to claim 38,
wherein a maximum surface roughness (R_{max}) of the substrate is equal to or less than
1 μm .

42. (Previously Presented) A device according to claim 38,
wherein a radius of curvature of convex portions existing on a surface of the substrate is
equal to or greater than 1 μm .

43. (Previously Presented) A device according to claim 38,
wherein the light emitting device is one selected from the group consisting of a video
camera, a digital camera, a goggle-type display, a navigation system for vehicles, a personal
computer, and a portable information terminal.

44. (Cancelled)

45. (Previously Presented) A device according to claim 2,
wherein a thin film transistor is over the substrate having the metallic surface.